



# PolyCharge America, Inc.

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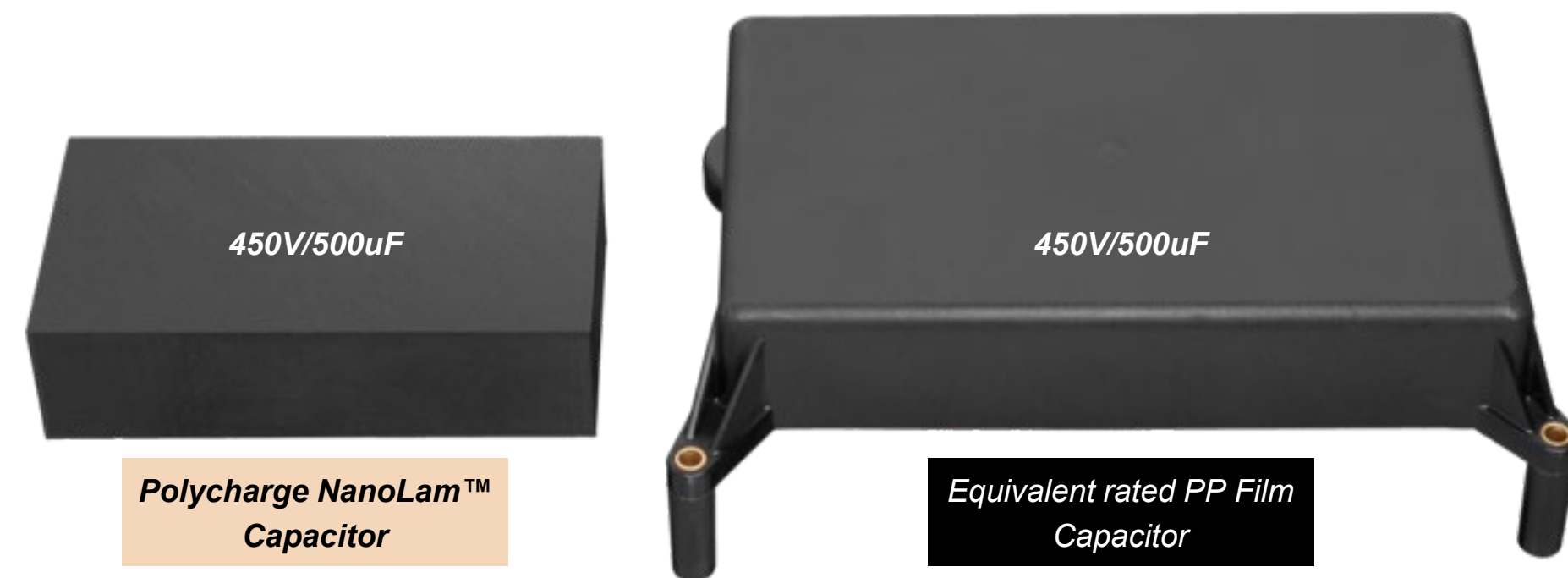
Steven Yializis

Chief Operating Officer

[yializis@polycharge.com](mailto:yializis@polycharge.com)

m. +1.520.440.8284

# ***PolyCharge NanoLam™ Capacitors...***



***SIGNIFICANTLY REDUCED VOLUME AND WEIGHT [ > 2x Energy Density ]***

*Sub-micron NanoLam™ thin film dielectrics means higher energy density when compared to polypropylene film capacitors.*

***140°C + 105°C***

*Polycharge NanoLam™ Capacitor*      *Polypropylene Film Capacitor*

***HIGHER OPERATING TEMPERATURES.***

*Radiation curable dielectric materials formulated for high temperature handling capabilities (and self-healing). Ideal for higher frequency and higher current applications.*

***... And COST Competitive***

# CONVENTIONAL TECHNOLOGY...

Polypropylene (PP) film is extruded, metallized, wound, processed, and packaged to create a finished capacitor.

- Quality extruded films produced by a small number of producers. Films are sold to capacitor manufacturers and 3rd-party metallizers.
- 2.2 $\mu$ m film is thinnest currently available. Thinner film = higher cost to produce.
- Polypropylene film currently represents the best combination of performance and price; however, achieving thinner films is problematic AND intrinsic operating temperatures limited (Max. 105°C).
- Metallized films are wound into capacitor “bobbins,” processed, and packaged to create the finished capacitor.



Example PP Film Extrusion Line.



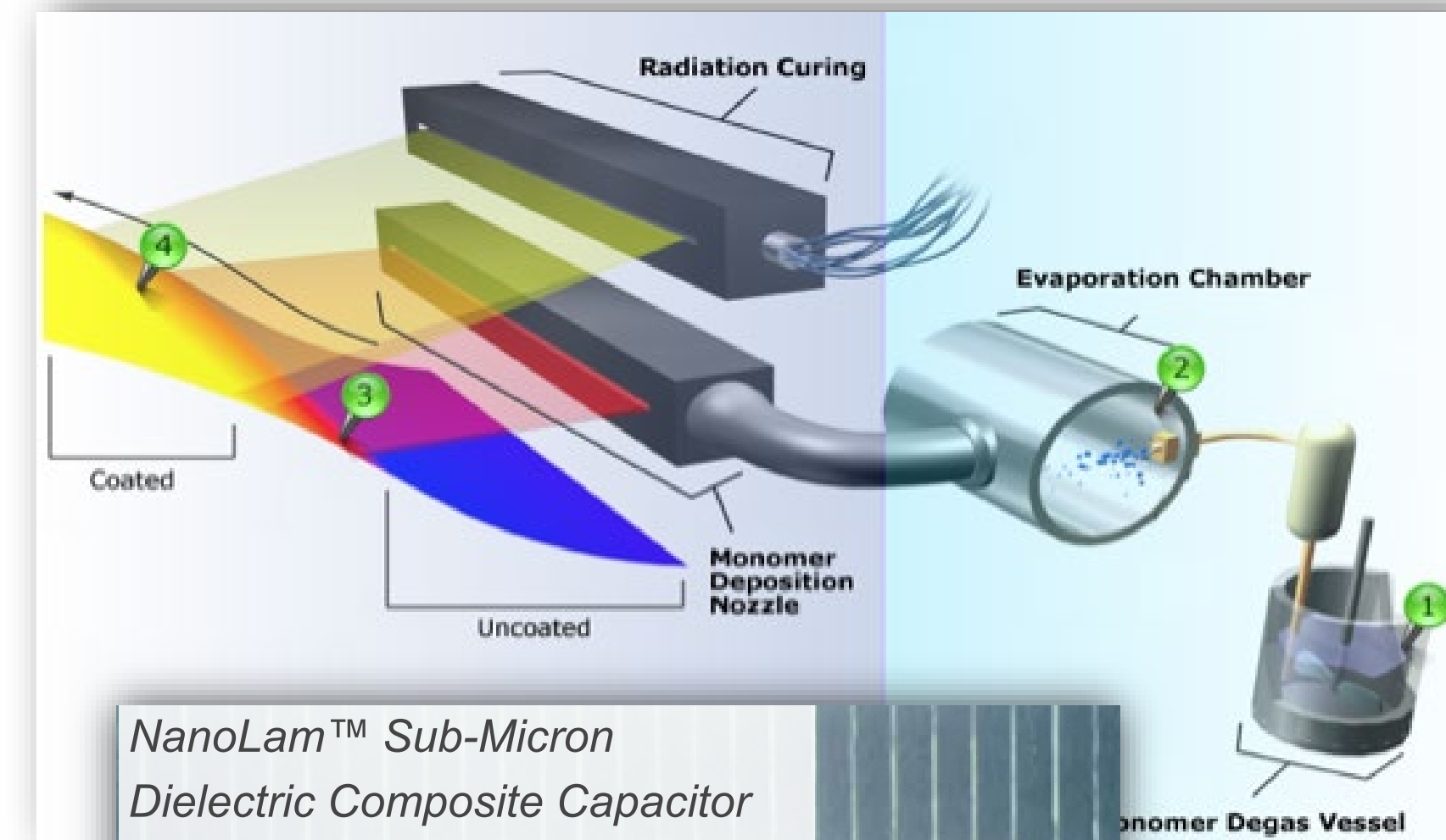
Example Metallizer



# Polycharge Nanolam™ Capacitor Fabrication

Thin film dielectric formation and electrode deposition combined in a single process step

- ELIMINATES THE FILM PRODUCER. Dielectric formation and metallization occur in a SINGLE PROCESS STEP reducing overall product cost.
- SUB-MICRON DIELECTRICS. Vapor deposited dielectrics ranging in thickness from 300 to 850 nanometers.
- HIGH TEMPERATURE DIELECTRICS. Thermoset (not thermoplastic, like PP) acrylic dielectrics capable of in-service temperatures in excess of 140°C (compared to 105°C for PP)
- PRISMATIC FORM FACTOR. For greater volumetric efficiency and lower inductance.
- COST COMPETITIVE. Fewer process steps. Low-cost materials. Supply chain flexibility.



Nanolam™ Sub-Micron Dielectric Composite Capacitor Material for producing high energy density, self-healing, DC-link capacitors

2.0µm

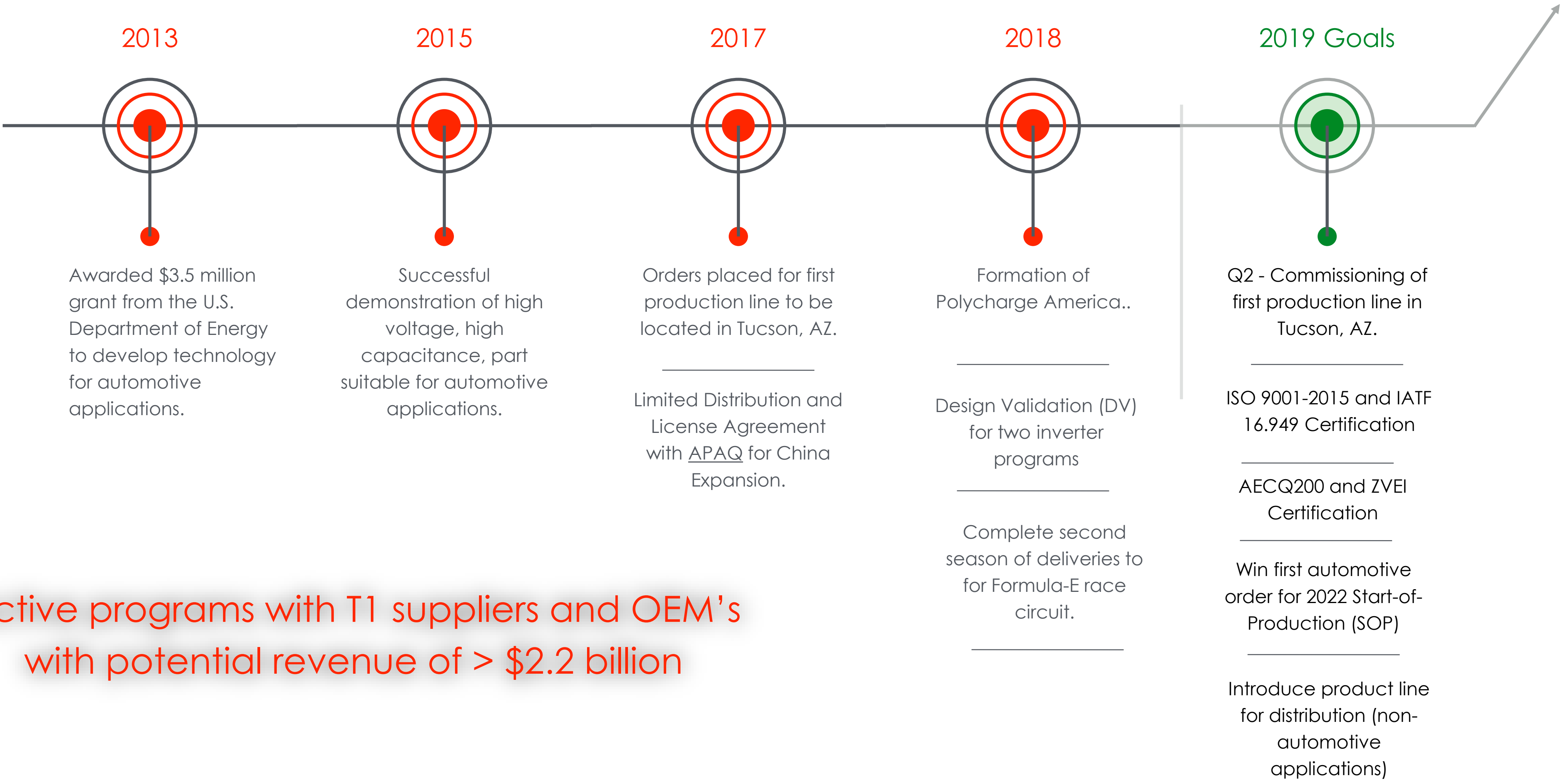


1-Machine for Dielectric Formation + Metallization

# Polycharge NanoLam™ Dielectrics Compared to Other Polymers

	<b>NanoLam™ Thermoset Dielectric</b>	<b>Polypropylene (PP)</b>	<b>Polyester (PET)</b>	<b>Polyethylene- naphthalate (PEN)</b>	<b>Polyphenylene- sulfide (PPS)</b>	<b>Teflon (PTFE)</b>
<b>Dielectric Constant (K)</b>	<b>3.2</b>	2.2	3.3	3.2	3	2.1
<b>Voltage Breakdown (V/μm)</b>	<b>&gt; 1000</b>	650	575	550	550	275
<b>Dissipation Factor (%)</b>	<b>&lt; 1.0</b>	< 0.1	< 1.5	< 1.0	< 0.2	< 1.0
<b>Max. Operating Temperature (°C)</b>	<b>140</b>	105	125	125	200	200
<b>Self Healing</b>	<b>Very Good</b>	Very Good	Good	Poor	Poor	Very Good
<b>Glass Transition Temperature (°C)</b>	<b>&gt; 200</b>	0	70	120	85	110
<b>Dielectric Thickness (μm)</b>	<b>0.40 - 1.00</b>	> 2	> 1	> 1	> 2	> 2
<b>Plastic Type</b>	<b>THERMOSET</b>	Thermoplastic	Thermoplastic	Thermoplastic	Thermoplastic	Thermoplastic

# Polycharge Achievements and 2019 Goals



Active programs with T1 suppliers and OEM's with potential revenue of > \$2.2 billion



**POLYCHARGE**

*Linking energy and motion*